Radiation-Hard Smart-Pixel Detector ASIC ReadOut with Digital Al in 28nm

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- 7 times higher interaction rate
- Raw data generation of 40ZB/year

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MOD

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LL

AI/ML

98.83 M new users

- create an in-pixel ADC with distinct reset and compare phases is required
- On chip data reduction capability using **AI/ML** techniques

PT Filter

PROT 0 Z FRONT ALOG

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IMPLEM

I/ML

- AFE Prototype designed in HPC+ 28nm
- ROIC pixel size is 25µm x 25µm
- Preamplifier dynamic range 64aC 2.1fC
- **Radhard** by design: 50nA leakage compensation
- Sampling at bunch crossing rate: 40MSPS
- Offset cancellation with auto-zero
- Equivalent noise charge (ENC) 31e- with 400ethreshold (no sensor cap)
- Total charge dispersion <100e- across entire

Injected Charge (electrons)

Filtering Algorithm for momentum Classifier

0.40 € 0.20 ysize 0.0 -2true PT (GeV) Charge projection on the y-axis correlates

1.00 0.95

0.90

v 0.60

with momentum $p_T = 1.9 \text{ GeV}$ ¹⁰ p_T = 135 MeV

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• Classifier models reject between 50% to 75% of the clusters

yprofile with timing info

yprofile

• More power savings due to reduced I/O transfer

matrix with 400e- threshold (no sensor cap)

Pixel Power ~5uW

S-curves of total dispersion for all hit comparators in the array with 400e- equivalent threshold voltages and no sensor capacitance connected to the ROIC

<u>leterence:</u>] Jieun Yoo1,*, Jennet Dickinson et al., "Smart pixel deep learning". Published 14 August 2024 "Machine arning: Science and Technology", Volume 5, Number 3

On-Chip Digital Momentum Classifier

- **Co-Design** development with analog frontend pixels connected to a fully combinatorial digital classifier
- **Combinatorial** design reduces dynamic power
- Digital power estimated to be 300uW for 256 pixels \rightarrow ~1uW/pixel
- Total power density (AFE + digital) < 1W/cm2

ASIC validation ongoing

Smart Pixel Implementation

Study and implement analog/hybrid AI/ML algorithm that can be distributed throughout the detector:

- Explore **analog** algorithms to efficiently process sensor signals at the source.
- Compression (or featurization)
 - 1. Train algorithms to extract real time physics data for triggering on interesting collisions
 - 2. Readout only the critical physics data instead of the raw detector data and figure out the calibration loop

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